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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10031000	01/16/2002	438		2812	

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**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A 371 OF PCT/JP00/04599 07/13/2000

** FOREIGN APPLICATIONS VERIFIED:

JAPAN 11/202847 07/16/1993

JAPAN 2000-63686 03/08/2000

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiner's initials		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO 2002-0024A
TITLE : Package of semiconductor device and method of manufacture thereof U.S. DEPT. OF COMM./PAT & TM-PTO-436L (Rev. 12-54)			

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.	Print Fig.
TERMINAL DISCLAIMER		Primary Examiner		
		PREPARED FOR ISSUE		
		Application Examiner		
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